

Doc. Number:

□ Tentative Specification

Preliminary Specification

限公司

□ Approval Specification

# **MODEL NO: DJ123IA** SUFFIX: 01B

**Customer:** 

APPROVED BY SIGNATURE

Name / Title Note :

Please return 1 copy for your confirmation with your signature and comments.

Approved By	Checked By	Prepared By
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#### **REVISION HISTORY**

Version	Date	Page	Description
0.0	Nov,11, 2015	All	Spec Ver.0.0 was first issued.
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# **1. General Specifications**

No.	Item	Specification	Remark
1	LCD Size	12.3 inch (Diagonal)	
2	Driver Element	a-Si TFT Active Matrix	
3	Resolution	1920 X 3(RGB) X 720	
4	Display Mode	Normally Black, Transmissive	
5	Dot Pitch	0.0508 x 0.1524	
6	Active Area	292.608(W) X 109.728(H) mm	LA LA
7	Module Size	310(W) X 129.1(H) X 7.5(D) mm	Note 1
8	Bezel Opening Size	295.61(W) X 112.73(H) mm	
9	Surface Treatment	Anti-Glare	
10	Color Arrangement	RGB-Stripe	
_11	Interface	2 Port LVDS(DE Only)	
12	Backlight Power Consumption	8.2W(TYP.)	
13	Panel Power Consumption	(1.5W)	
14	Weight	463g (MAX.)	
15	NTSC	85%	

Note 1: Refer to Mechanical Drawing.



# 2. Pin Assignment

Connector on PCB is used for the module electronics interface. The recommended model is 12003S-50Y900 manufactured by IRISO.

	Connector type : IRISO 12003S-50Y900						
Pin	Input signal name	I/Opin (I:input, O:output, P:power)	Typical v	voltage (Volt)	description		
1	GND	Р	0.00 V	power supply	Ground		
2	VDD	Р	3.3 V	power supply	External main and I/O power supply ; Power3V3		
3	VDD	P	3.3 V	power supply	External main and I/O power supply : Power3V3		
4	NC			Function	LCD Maker Internal Use		
5	RESET	I	3.3V or 0V	Function	Global reset pin (Default high), active low.		
6	STBYB	Ι	3.3V or 0V	Function	Standby mode setting pin (Default high), active low.		
7	GND	Р	0.00 V	power supply	Ground		
8	OLV0N	Ι		LVDS signal	LVDS odd data 0-		
9	OLV0P	I		LVDS signal	LVDS odd data 0+		
10	GND	Р	0.00 V	power supply	Ground		
11	OLV1N		-111	LVDS signal	LVDS odd data 1-		
12	OLV1P		とは	LVDS signal	LVDS odd data 1+		
13	GND	Р	0.00 V	power supply	Ground		
14	OLV2N		FLE	LVDS signal	LVDS odd data 2-		
15	OLV2P	1	FK	LVDS signal	LVDS odd data 2+		
16	GND	Р	0.00 V	power supply	Ground		
17	OLVCLKN	AA		LVDS signal	LVDS odd clk -		
18	OLVCLKP	I		LVDS signal	LVDS odd clk +		
19	GND	Р	0.00 V	power supply	Ground		
20	OLV3N	I		LVDS signal	LVDS odd data 3-		
21	OLV3P	I		LVDS signal	LVDS odd data 3+		
22	GND	Р	0.00 V	power supply	Ground		
23	ELV0N	I		LVDS signal	LVDS even data 0-		
24	ELV0P	I		LVDS signal	LVDS even data 0+		
25	GND	Р	0.00 V	power supply	Ground		
26	ELV1N	I		LVDS signal	LVDS even data 1-		
27	ELV1P	I		LVDS signal	LVDS even data 1+		
28	GND	Р	0.00 V	power supply	Ground		
29	ELV2N	Ι		LVDS signal	LVDS even data 2-		
30	ELV2P	I		LVDS signal	LVDS even data 2+		
31	GND	Р	0.00 V	power supply	Ground		
32	ELVCLKN	I		LVDS signal	LVDS even clk -		
33	ELVCLKP	l		LVDS signal	LVDS even clk +		
34	GND	Р	0.00 V	power supply	Ground		
35	ELV3N			LVDS signal	LVDS even data 3-		
36	ELV3P	l		LVDS signal	LVDS even data 3+		
37	GND	P	0.00 V	power supply	Ground		
38	GND	Р	0.00 V	power supply	Ground		



39	RL	I	3.3V or 0V	Function	Horizontal shift direction (source output) selection. RL = 1: Left -> Right(default: Customer to Pull high, internal IC Pull high*) RL = 0: Right -> Left	
40	ТВ	I	3.3V or 0V	Function	Vertical shift direction (gate output) selection. TB = 0: Bottom->Top TB = 1: Top ->Bottom (default: Customer to Pul high, internal IC Pull high*)	
41	NC				LCD Maker Internal Use, Keep floating	
42	NC				LCD Maker Internal Use, Keep floating	
43	NC				LCD Maker Internal Use, Keep floating	
44	VDD	Р	3.3 V	power supply	External main and I/O power supply ; Power3V3	
45	NC				Keep floating	
46	NC				Keep floating	
47	NC				Keep floating	
48	NC				Keep floating	
49	NC				Keep floating	
50	NC				Keep floating	

#### The recommended model of FPC Connector is 12001S-10Y901 manufactured by IRISO

Connector type : IRISO IMSA-12001S-10Y901					
PIN No.	Symbol	1/0	Function		
1	PLED 🍏	Power	LED anode power supply		
2	PLED	Power	LED anode power supply		
3	PLED	Power	LED anode power supply		
4	NC				
5	NTC1		heat sensor		
6	NTC2(GND)		heat sensor		
7	NLED	Power	LED cathode power supply		
8	NLED	Power	LED cathode power supply		
9	NLED	Power	LED cathode power supply		
10	NLED	Power	LED cathode power supply		





Note: Definition of scanning direction. Refer to the figure as below:



# 3. Operation Specifications

## 3.1. Absolute Maximum Rating

(GND=0V, Note 1)

ltom	Symbol	Val	ues	Unit	Domork	
item	Symbol	Min.	Max.	Unit	Remark	
Power Voltage	V <sub>dd</sub>	-0.3	(3.96)	v	Note 1	
Operation Temperature	Т <sub>ор</sub>	-30	85	°C	Note2, 3, 4	
Storage Temperature	Τ <sub>st</sub>	-40	90	°C	Note2, 3	

Note 1 : The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

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Note 2 : This rating applies to all parts of the module and should not be exceeded.

Note 3 : Maximum wet-bulb temperature is 58°C. Condensation of dew must be avoided as electrical current leaks will occur, causing a degradation of performance specifications.

Note 4 : The operating temperature only guarantees operation of the LCM and doesn't guarantee all the contents of Electro-optical specification.



3.1.1 Typical Operation Conditions

						(GND =0V)
	Symbol		Values	11	Demente	
ltem		Min.	Тур.	Max.		Remark
Power voltage	V <sub>DD</sub>	3.1	3.3	3.6	v	Note 1,2
Power Supply Input Current	I <sub>DD</sub>		(450)	(500)	mA	Note 3
Input logic high voltage	V <sub>IH</sub>	0.7 V <sub>DD</sub>	-	V <sub>dd</sub>	v	Hole o
Input logic low voltage	V <sub>IL</sub>	GND	-	0.3 V <sub>DD</sub>	v	Note 1
Pull low / high resistor	RI	125	250	375	kΩ	For I/O circuit

Note 1: V<sub>DD</sub> setting should match the signals output voltage of customer's system board. Note 2: The ripple voltage should be controlled under 5% of V<sub>DD</sub> Note 3: RESET, STBYB, BISTEN, FCS, RL, TB



#### 3.1.2 Backlight Driving Conditions

ltom	Symbol	Values			Unit	Domork
item	Symbol	Min.	Тур.	Max.	Unit	Remark
Voltage for LED Backlight	VL	33.6	37.2	39.6	v	Note 1
Current for LED Backlight	IL.		(220)		mA	
LED Life Time	-	30000			Hr	Note 2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25℃ and I<sub>L</sub> =(220)mA. Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25℃ and I<sub>L</sub> = 220 )mA. The LED lifetime could be decreased if operating I<sub>L</sub> is lager than (220) mA.

#### 3.1.3 PWM



#### **Thermal Simulation**

1. After several condition comparison, we will use the LED with metalcore PCB + Heat-sink for this case.

2. 48pcs LEDs with total 8.2W

VDD = 3.0~3.6V



- 3. The optical film will be the first to reach the material limit.
- 4. By simulation result, we need to start to de-rating the BLU from 62 degree C to protect the material safe.

### 3.2. Power Sequence

#### 3.2.1 Power on:

10% **90%** t1 4 VDD 0V t2 ÷ RESET 0V t4 l← LVDS signal 0V t3  $\rightarrow$ <del>(</del> STBYB 0V t5 BL 0V 3.2.2 Power off: t10 VDD t9 <del>(</del> 90% 10% 10% 90% 0V RESET 0V t8 LVDS signal <u>ον</u> t7 ← 0V STBYB t6 <del>(</del> -> 0V BL

Symbol		llnit		
Symbol	Min.	Тур.	Max.	Unit
t1	1.5	2	3	ms
t2	1.0	5	10	ms
t3	0	30	50	ms
t4	0	5	10	ms
t5	10	12	15	frame
t6	0	25	50	ms
t7	7	9	10	frame
t8	8	10	11	frame
t9	0	1	3	ms



t10 1000	2000	3000	ms
----------	------	------	----

## 3.3. Timing Characteristics

#### 3.3.1. AC Electrical Characteristics

Deremeter	Symbol		Spec.		l lmit	Dements	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Remark	
Clock frequency	FLVCYC	20	-	85	MHz	Frame rate=60Hz	
Clock Period	TLVCYC	11.76	-	50	Nsec	Frame rate=60Hz	
1 data bit time	UI	-	1/7	-	TLVCYC		
Position 1	TPOS1	-0.2	0	0.2	UI		
Position 0	TPOS0	0.8	1	1.2	UI		
Position 6	TPOS6	1.8	2	2.2	UI	八百	
Position 5	TPOS5	2.8	3	3.2	UI	服公	
Position 4	TPOS4	3.8	4	4.2	UT	Nata	
Position 3	TPOS3	4.8	5	5.2	Hu	Notes	
Position 2	TPOS2	5.8	61	6.2	UI	LL	
Input eye width	TEYEW	0.6	たって	IS	UI		
Input eye border	TEX	と智い	00	0.2	UI		
LVDS wake up time	TENLVDS	TIE	CIN	150	ns		

Note9 : Please refer to "3.3.2 Input Clock and Data Timing Diagram"

#### 3.3.2. Input Clock and Data Timing Diagram

#### **LVDS input timing:**





# Differential: LVD[3:0]P-LVD[3:0]N LVDS input eye diagram LVDS input eye diagram



#### 3.3.3. DC Electrical Characteristics

Deremeter	Symbol	Spec.			l loit	Domorik	
Parameter	Symbol	Min.	. Typ. Max.		Unit	Nenial K	
Differential input high Threshold voltage	Vth	-	-	+0.1	v	Vcm-1 2V	
Differential input low Threshold voltage	Vtl	-0.1	-	-	v		
Differential input common Mode voltage	Vcm	1	1.2	1.7- V <sub>id</sub>  /2	v	-	
Differential input voltage	Vid	0.2	-	0.6	V	-	
Differential input leakage Current	Vleak	-10	-	+10	μA	-	

Single-ended: LVCLKP(R), LVCLKN(R), LVD[3:0]P(R), LVD[3:0]N(R)



Differential: LVCLKP(R)-LVCLKN(R), LVD[3:0]P(R)-LVD[3:0]N(R)



#### 3.3.4. Timing

Parameter	Symbol	192 (Tw	Unit		
		Min.	Тур.	Max.	•
CLK frequency	F <sub>CLK</sub>	-	44.1	-	MHz
Horizontal valid data	t <sub>hd</sub>	960			DCLK
1 Horizontal Line	th	984	992	1005	DCLK
Vertical valid data	t <sub>vd</sub>	720			Н
1 Vertical field	t <sub>v</sub>	730 741 753		Н	
Frame rate	FR	59.4	60	60.6	Hz

Note: DE mode only.



#### 3.3.5. Data Input Format

Panel LVDS format follow standard LVDS format:







#### 3.3.6. Reset timing

RESETB		VIH1 VIL1		tRW		tRT		
Internal state	e			Reset in	progress		ormal operation	
Signal	Parameter	Symbol	Min.	Spec. Typ.	Max.	Unit	Remark	
	Reset pulse width	tRW	10	-	-	μs	八三	
RESETB	Reset complete time	tRT	-	-	5	μs	12rs	
	Negative spike noise width	tNNS	-	.12	1007	Ins	-	
THIT ELECTRONICS INTED								



# 4. Optical Specifications

kom	Cumhal	Symbol Condition		Values		11:4	Domork	
item	Symbol	Condition	Min.	Тур.	Max.	Unit	Nemark	
	θι	Φ=180 (9 o'clock)		85	-	degree	Note 4	
Viewing angle	θ <sub>R</sub>	Φ=0°(3 o'clock)		85	-			
Item Viewing angle (CR≥ 10) Response time Contrast ratio Color chromaticity NTSC Gamma Luminance	θτ	Φ=90°(12 o'clock)		85	-		NOLE I	
	θΒ	Φ=270 (6 o'clock)		85	-			
Posponeo timo	T <sub>ON</sub>		-	15	20	msec	Note 2,3	
Response time	T <sub>OFF</sub>		-	10	15	msec		
Contrast ratio	CR		(700)	1000	-	-	Note 2,4	
	Wx	Normat θ=Φ=0°	(0.273)	(0.313)	(0.353)	限公	Note 2.5.6	
	W <sub>Y</sub>		(0.289)	(0.329)	(0.369)		NOLE 2,3,0	
	Rx		(0.602)	(0.642)	(0.682)	O.		
Color chromaticity	Ry		(0.254)	(0.294)	(0.334)			
color enromaticity	Gx		(0.234)	(0.274)	(0.314)			
	Gy		(0.635)	(0.675)	(0.715)			
	Bx		(0.112)	(0.152)	(0.192)			
	Ву		(0.028)	(0.068)	(0.108)			
NTSC	Nu-		80	85	90	%	Note 2	
Gamma			1.9	2.2	2.5		Note 2	
Luminance	L		(600)	750	-	cd/m²	Note 2,6	
Luminance uniformity	Yu		75	80	-	%	Note 2,7	

**Test Conditions:** 

1.  $I_L$ = 220mA(Backlight current), the ambient temperature is 25°C.

2. The test systems refer to Note 2.



#### Note 1: Definition of viewing angle range.

The view angel for  $\Theta$ =85° is measured by BM-5A.



#### Fig. 4-2 Optical measurement system setup



#### Note 3: Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (Ton) is the time between photo detector output intensity changed from 10% to 90%, and fall time (Toff) is the time between photo detector output intensity changed from 90% to 10%.



Note 6: All input terminals LCD panel must be ground while measuring the center area of the panel. The LED driving condition is IL=(220mA).



#### Note 7: Definition of luminance uniformity

Active area is divided into 9 measuring areas.

Luminance Uniformity (Yu) = 
$$\frac{B_{min}}{B_{max}}$$









# 5. Reliability Test Items

Item	Test Conditions	Remark
High Temperature Storage Test	Ta = 90ºC, 504 hours	
Low Temperature Storage Test	Ta=-40⁰C, 504 hours	
High Temperature Operation Test	Ts=85ºC, 504 hours	
Low Temperature Operation Test	Ta=-30⁰C, 504 hours	(1) (2) <mark>(4)</mark> (5)
High Temperature & High Humidity Operation Test	Ta=60ºC, RH 90%, 504 hours	
Thermal Shock	(Ta=-30℃ 30min)→(Ts=85℃ 30min)]/cycle, 100cycles	1
ESD Test (Operation)	Condition 1 : C = 150pF, R = 330_ Contact Discharge, <b>±</b> 8KV Condition 2 : C = 150pF, R = 330_, Air Discharge, <b>±</b> 15KV	(5)
Mechanical Shock	100G, 6ms, half sine wave, 3 times for each direction of $\pm X$ , $\pm Y$ , $\pm Z$	(1)(3)
Mechanical Vibration	Frequency: 10 ~55~10Hz;Sweep Mode: Log Sweep Sweep time: 1Oct/min; Acceleration: 1.5G;Test time:2 hr for each direction of X, Y, Z.	(1)(3)
Packaging Vibration Test	1.47Grms X, Y, Z three axes (30min /axis) [Spectrum : 5Hz(0.015G2/Hz) , 100Hz(0.015G2/Hz) , 200Hz(0.0037G2/Hz)]	
Win	1corner, 3edges, 6faces (1 time/direction) <follow height="" ista(1a)=""></follow>	
	0kg≦W<10kg ∶ 76cm,	
Packaging Drop Test	10kg≦W<19kg ∶ 61cm,	
	19kg≦W <28kg ∶ 46cm,	
	28kg≦W<45kg ∶ 31cm,	
	45kg≦W≦68kg : 20cm	

Note (1) Ta is ambient temperature, Ts is panel surface temperature.

Note (2) Evaluation should be tested after storage at room temperature for more than two hour.

Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.

Note (4) A certain level of Mura (non-uniformity) of dark / black image will happen several days after high temperature testing (H.T.T.). There is a slowly part recovery over a long time (several months).Such a long exposure time like in H.T.T. will normally not happen in a real application. Therefore the test H.T.T. was introduced to simulate cycles with normal conditions in-between but with the same total exposure time what show a significant reduced Mura.

The root cause is related to tension generated due to different amount of shrinking in the stack of layers in the polarizer sheet.

The effect is more significant on larger displays like this size. An investigation into alternative polarizer material showed that there is no better alternative currently available.

Note (5) Criteria Class B: Some performance degradation allowed. No data loss. Self-recoverable. No hardware failures.







# 6. General Precautions 6.1. Safety

Liquid crystal is poisonous. Do not put it in your mouth. If liquid crystal touches your skin or

clothes, wash it off immediately by using soap and water.

## 6.2. Handling

1. The LCD panel is plate glass. Do not subject the panel to mechanical shock or to excessive force on its surface.

2. The polarizer attached to the display is easily damaged. Please handle it carefully to avoid scratch or other damages.

3. To avoid contamination on the display surface, do not touch the module surface with bare hands.

4. Keep a space so that the LCD panels do not touch other components.

5. Put cover board such as acrylic board on the surface of LCD panel to protect panel from damages

6. Transparent electrodes may be disconnected if you use the LCD panel under environmental conditions where the

condensation of dew occurs.

7. Do not leave module in direct sunlight to avoid malfunction of the ICs.

## 6.3. Static Electricity

1. Be sure to ground module before turning on power or operating module.

2. Do not apply voltage which exceeds the absolute maximum rating value.

## 6.4. Storage

1. Store the module in a dark room where must keep at 25±10  ${\mathbb C}$  and 65%RH or less.

2. Do not store the module in surroundings containing organic solvent or corrosive gas.

3. Store the module in an anti-electrostatic container or bag.

## 6.5. Cleaning

1. Do not wipe the polarizer with dry cloth. It might cause scratch.

2. Only use a soft sloth with IPA to wipe the polarizer, other chemicals might permanent damage

to the polarizer.



# 7. Mechanical Drawing





# 8. Packing Drawing

## 8.1 Packaging Material Table

No.	ltem	Model (Material)	Dimensions(mm)	Unit Weight (kg)	Quantity	Remark
1	LCM Module	Model Name	310(W) X 129(H) X 7.5(D) mm	0.53	20	
2	EPO Box	EPO	542 x 382 x 182mm	0.61	1	
3	A/S Bag	PE	340 x 183 x 0.04mm	0.006	20	
4	Carton	Corrugated Paper	566 x 406 x 216mm	1.014	1	
5	Total Weight	12.34 kg		L.	一眼儿	L'EI

## 8.2 Packaging Quantity

Total LCM quantity in Carton: 20pcs



8.3 Packaging Drawing





8.4 Shipping Drawing

